

Product Discontinuation Notice for Development Systems Products – China, Russia and Vietnam

XCN20005 (v1.0) June 15, 2020

Product Discontinuation Notice

Overview

The purpose of this notification is to communicate that Xilinx[®] is discontinuing the Zynq UltraScale+ RFSoC ZCU111 Encryption Disabled Evaluation Kit, Zynq UltraScale+ RFSoC ZCU1275 Encryption Disabled Characterization Kit and Zynq UltraScale+ RFSoC ZCU1285 Encryption Disabled Characterization Kit.

Description

In response to the issuance by Bureau of Industry and Security (BIS) of new export regulations that eliminate the License Exception CIV, which will be effective on June 29, 2020, Xilinx Export Global Trade Compliance Team (GTC) is modifying the guidance for RFSoC-based boards shipped into China, Russia, and Vietnam. Any RFSoC-based board shipped on or after June 29th must be the standard, non- "encryption disabled" version (-G designator). This would include shipments into Hong Kong to support orders in China.

This notice should be used in conjunction with previous discontinuance notices which can be found at Xilinx.com.

Note: Products shipped to all other countries are not impacted by this PDN.

Products Affected

- ZCU111 Encryption Disabled Evaluation Kit
- ZCU1275 Encryption Disabled Characterization Kit
- ZCU1285 Encryption Disabled Characterization Kit

Table 1: Zynq UltraScale+ RFSoC ZCU111 Encryption Disabled Evaluation

Part Number	Description	Replacement Part
EK-U1-ZCU111-G-ED	Zynq UltraScale+ RFSoC ZCU111 Encryption Disabled Evaluation	EK-U1-ZCU111-G

Table 2: Zyng UltraScale+ RFSoC ZCU1275 Encryption Disabled Characterization Kit

Part Number	Description	Replacement Part
CK-U1-ZCU1275-G-ED	Zynq UltraScale+ RFSoC ZCU1275 Encryption Disabled Characterization Kit	CK-U1-ZCU1275-G

Table 3: Zynq UltraScale+ RFSoC ZCU1285 Encryption Disabled Characterization Kit

Part Number	Description	Replacement Part
CK-U1-ZCU1285-G-ED	Zynq UltraScale+ RFSoC ZCU1285 Encryption Disabled Characterization Kit	CK-U1-ZCU1285-G

Key Dates and Ordering Information

Final orders accepted until June 22, 2020 or until inventory is exhausted whichever comes first. Final shipments will be until June 28, 2020.

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Response

Customers are requested to place last-time-buy orders in a timely manner prior to the key dates listed above to avoid product availability issues. If you anticipate that your last time buy requirements will exceed the current rate, please provide your Xilinx Sales Representative with a forecast of the requirements. All orders will be supported on a first-come, first-served basis. All orders placed within 60 days of the last time buy date will be non-cancellable and non-returnable (NCNR). For additional information or questions, contact your local Xilinx Sales representative.

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Revision History

The following table shows the revision history for this document.

Date	Version	Revision
06/15/2020	1.0	Initial release.

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